

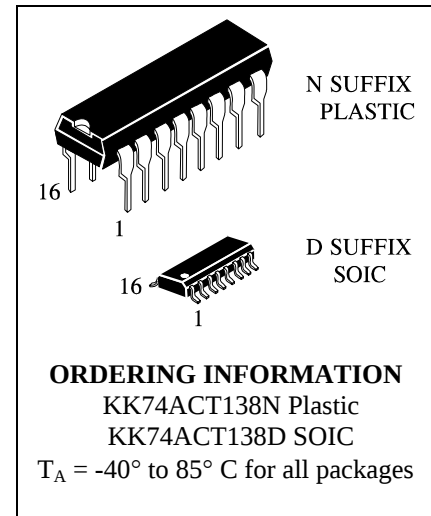
KK74ACT138

1-of-8 Decoder/Demultiplexer High-Speed Silicon-Gate CMOS

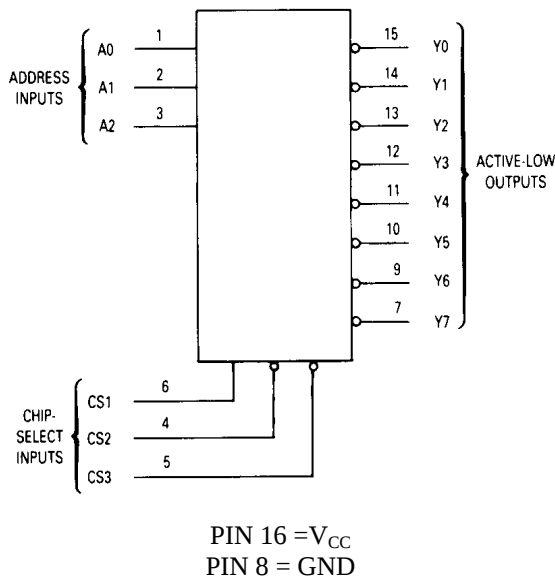
The KK74ACT138 is identical in pinout to the LS/ALS138, HC/HCT138. The KK74ACT138 may be used as a level converter for interfacing TTL or NMOS outputs to High Speed CMOS inputs.

The KK74ACT138 decodes a three-bit Address to one-of-eight active-low outputs. This device features three Chip Select inputs, two active-low and one active-high to facilitate the demultiplexing, cascading, and chip-selecting functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output; one of the Chip Selects is used as a data input while the other Chip Selects are held in their active states.

- TTL/NMOS Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1.0 μ A; 0.1 μ A @ 25°C
- Outputs Source/Sink 24 mA



LOGIC DIAGRAM



PIN ASSIGNMENT

A0	1	16	V _{CC}
A1	2	15	Y0
A2	3	14	Y1
CS2	4	13	Y2
CS3	5	12	Y3
CS1	6	11	Y4
Y7	7	10	Y5
GND	8	9	Y6

FUNCTION TABLE

Inputs				Outputs							
CS1	CS2	CS3	A2 A1 A0	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	X	H	X X X	H	H	H	H	H	H	H	H
X	H	X	X X X	H	H	H	H	H	H	H	H
L	X	X	X X X	H	H	H	H	H	H	H	H
H	L	L	L L L	L	H	H	H	H	H	H	H
H	L	L	L L H	H	L	H	H	H	H	H	H
H	L	L	L H L	H	H	L	H	H	H	H	H
H	L	L	L H H	H	H	H	L	H	H	H	H
H	L	L	H L L	H	H	H	H	L	H	H	H
H	L	L	H L H	H	H	H	H	H	L	H	H
H	L	L	H H L	H	H	H	H	H	H	L	H
H	L	L	H H H	H	H	H	H	H	H	H	L

H = high level (steady state)

L = low level (steady state)

X = don't care

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V_{IN}	DC Input Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
I_{IN}	DC Input Current, per Pin	± 20	mA
I_{OUT}	DC Output Sink/Source Current, per Pin	± 50	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	± 50	mA
P_D	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
Tstg	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C
SOIC Package: - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V_{IN}, V_{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V_{CC}	V
T_J	Junction Temperature (PDIP)		140	°C
T_A	Operating Temperature, All Package Types	-40	+85	°C
I_{OH}	Output Current - High		-24	mA
I_{OL}	Output Current - Low		24	mA
t_r, t_f	Input Rise and Fall Time * (except Schmitt Inputs)	$V_{CC} = 4.5\text{ V}$ 0 $V_{CC} = 5.5\text{ V}$ 0	10 8.0	ns/V

* V_{IN} from 0.8 V to 2.0 V

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V _{CC} V	Guaranteed Limits		Unit
				25 °C	-40°C to 85°C	
V _{IH}	Minimum High-Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	4.5 5.5	2.0 2.0	2.0 2.0	V
V _{IL}	Maximum Low - Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	4.5 5.5	0.8 0.8	0.8 0.8	V
V _{OH}	Minimum High-Level Output Voltage	I _{OUT} ≤ -50 μA	4.5 5.5	4.4 5.4	4.4 5.4	V
		*V _{IN} =V _{IH} or V _{IL}	4.5	3.86	3.76	
		I _{OH} =-24 mA I _{OH} =-24 mA	5.5 5.5	4.86 4.86	4.76 4.76	
V _{OL}	Maximum Low-Level Output Voltage	I _{OUT} ≤ 50 μA	4.5 5.5	0.1 0.1	0.1 0.1	V
		*V _{IN} = V _{IH} or V _{IL}	4.5	0.36	0.44	
		I _{OL} =24 mA I _{OL} =24 mA	5.5 5.5	0.36 0.36	0.44 0.44	
I _{IN}	Maximum Input Leakage Current	V _{IN} =V _{CC} or GND	5.5	±0.1	±1.0	μA
ΔI _{CCT}	Additional Max. I _{CC} /Input	V _{IN} =V _{CC} - 2.1 V	5.5		1.5	mA
I _{OLD}	+Minimum Dynamic Output Current	V _{OLD} =1.65 V Max	5.5		75	mA
I _{OHD}	+Minimum Dynamic Output Current	V _{OHD} =3.85 V Min	5.5		-75	mA
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{IN} =V _{CC} or GND	5.5	8.0	80	μA

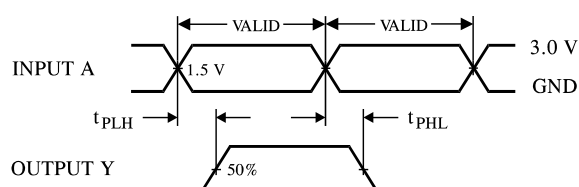
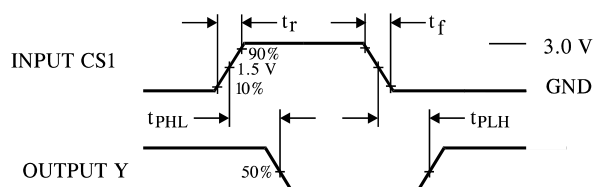
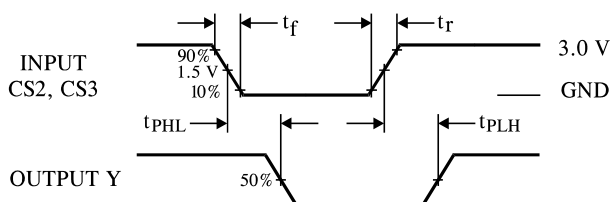
* All outputs loaded; thresholds on input associated with output under test.

+Maximum test duration 2.0 ms, one output loaded at a time.

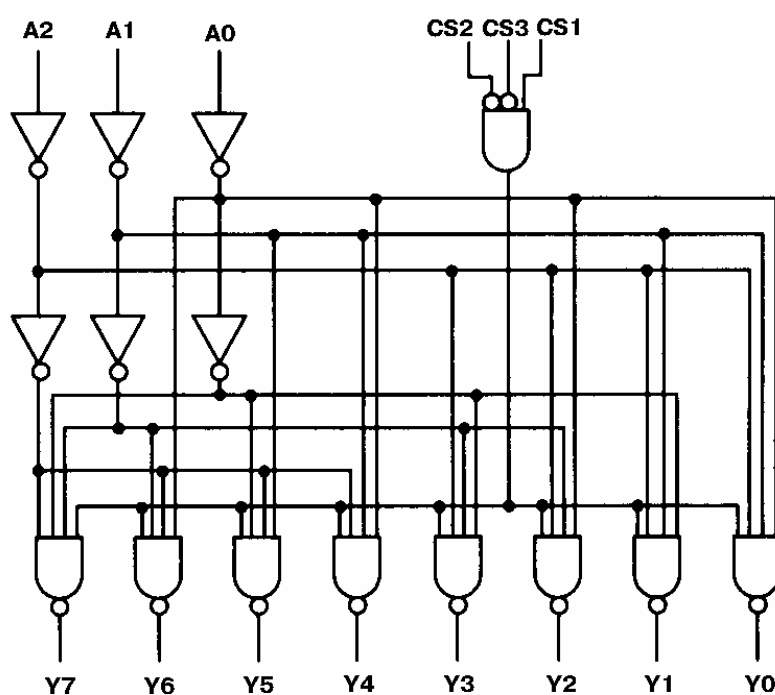
AC ELECTRICAL CHARACTERISTICS ($V_{CC}=5.0\text{ V} \pm 10\%$, $C_L=50\text{ pF}$, Input $t_r=t_f=3.0\text{ ns}$)

Symbol	Parameter	Guaranteed Limits				Unit
		25 °C		-40°C to 85°C		
		Min	Max	Min	Max	
t _{PLH}	Propagation Delay, Input A to Output Y (Figure 1)	1.5	10.5	1.5	11.5	ns
t _{PHL}	Propagation Delay, Input A to Output Y (Figure 1)	1.5	10.5	1.5	11.5	ns
t _{PLH}	Propagation Delay, CS2 or CS3 to Output Y (Figure 3)	2.5	11.5	2.0	12.5	ns
t _{PHL}	Propagation Delay, CS2 or CS3 to Output Y (Figure 3)	2.0	11.5	2.0	12.5	ns
t _{PLH}	Propagation Delay, CS1 to Output Y (Figure 2)	2.5	12.0	2.0	13.0	ns
t _{PHL}	Propagation Delay, CS1 to Output Y (Figure 2)	2.0	10.5	1.5	11.5	ns
C _{IN}	Maximum Input Capacitance	4.5		4.5		pF

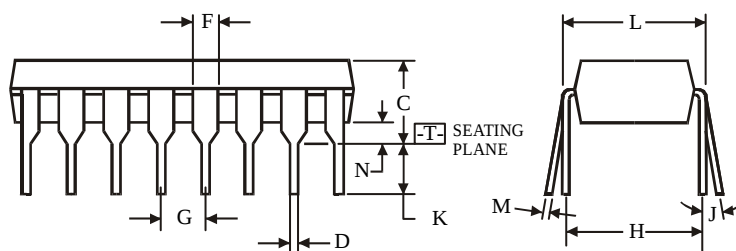
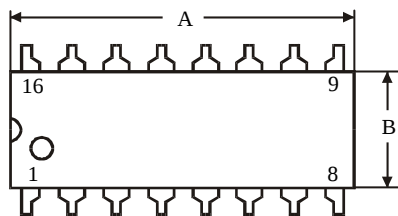
C _{PD}	Power Dissipation Capacitance	Typical @25°C, V _{CC} =5.0 V	pF
		60	


Figure 1. Switching Waveforms

Figure 2. Switching Waveforms

Figure 3. Switching Waveforms

EXPANDED LOGIC DIAGRAM



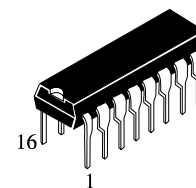
N SUFFIX PLASTIC DIP (MS - 001BB)



$\oplus 0.25 (0.010) \text{ (M) T}$

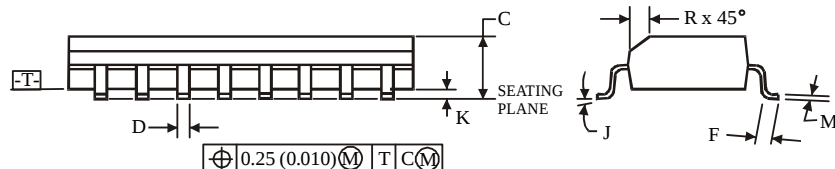
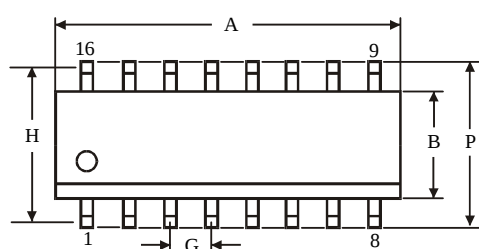
NOTES:

- Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.



	Dimension, mm	
Symbol	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

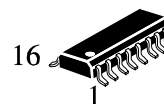
D SUFFIX SOIC (MS - 012AC)



$\oplus 0.25 (0.010) \text{ (M) T C (M)}$

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side
for A; for B - 0.25 mm (0.010) per side.



	Dimension, mm	
Symbol	MIN	MAX
A	9.8	10
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.72	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5